## Part Number Creator

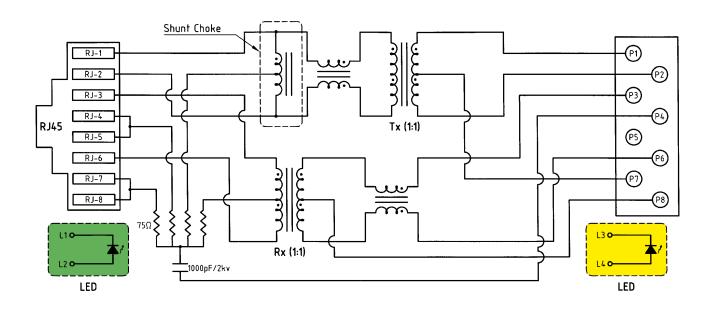
		RJ45	J	S		A	C	0	IN	U
Product	t Line									
PCB-Ter	rmination									
	= Solder pin, straight = SMT									
Contac										
	<ul> <li>Min. 50 micro inch, 1.27µ gold plated over nickel</li> <li>Other plating options are avaible.</li> </ul>									
Shieldin	<b>ng</b> ⊧Fully shielded									
5										
	r of ports									
	= 1 Port = 2 Ports									
4 =	= 4 Ports									
	= 6 Ports									
8 =	= 8 Ports									
Numbe	r of rows									
1 =	= 1 row									
Turns ra	atio of transformer									
A =	= 1:1/1:1 (Tx/Rx)									
B =	= 1:1.414/1:1 (Tx/Rx) Other turns ratio of transformer are avaible, please contact factory.									
	other turns ratio of transformer are available, prease contact rationy.									
	choke option									
	= With shunt choke in transmit channel = Without shunt choke in transmit channel									
	ince matching resistors = Without impedance matching resistors									
LED Co	lor options									
	= Without LED = Green LED (left), yellow LED (right)									
	Other LED combinations are available, please contact factory.									
Standa	rd									
	= Standard									

# **TECHNICAL DATA**

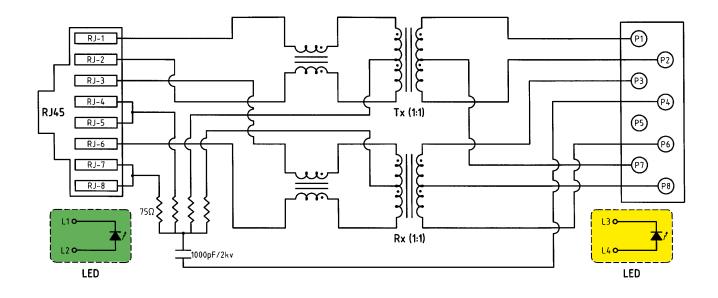
Specifications						
Housing, solder pin, straight	Polyester glass filled, black, UL94 V-O					
Housing, SMT-Termination	Nylon 46 glass filled, black, UL94 V-O					
Shielding		.008"/0.20 mm thick copper alloy				
Contact material		.014"/0.35 mm thick copper alloy				
Mating area plating	-	$50\mu''/1.27 \mu m$ gold min. over $30\mu''/0.76 \mu m$ min. nickel				
Solder tails plating	Tin plated					
OCL (Open Circuit Inductance)	Min. 350 µH at 8r	nA DC bias				
Leakage inductance	Max. 0.35 µH					
Inter-winding capacitance	Max. 25 pF					
DC-Resistance	Max. 1.0 Ω					
Turns ratio	1:1/1:1 ± 3% or T	$1:1/1:1 \pm 3\%$ or Tx/Rx = $1:1.414/1:1 \pm 3\%$				
Rise time and fall time	3.0 ns (typical)					
Mating force	Max. 22 N	Max. 22 N				
Retention force	Min. 89 N	Min. 89 N				
Mating cycles	Min. 1 000					
Contact resistance	Max. 20 mΩ					
Insulation resistance	Min. 1000 m $\Omega$	Min. 1000 mΩ				
Dielectric with standing voltage		1 500V ms (Signal to Shield)				
Current rating	Max. 0,05A	Max. 0,05A				
Spezification at 25°C (Operating temperature -40°C to +85°C)						
Insertion loss	0.1-100 MHZ	1.0 dB max				
Return loss	0.1-30 MHZ	20.0 dB Type				
	60 MHZ	15.0 dB Type				
	80 MHZ	12.0 dB Type				
Next near and cross talk	0.1-30 MHZ	50.0 dB Type				
	60 MHZ	45.0 dB Type				
	100 MHZ	40.0 dB Type				
Differential to common mode rejection	60 MHZ	40.0 dB Type				
	100 MHZ	35.0 dB Type				
Common mode rejection ration	60 MHZ	35.0 dB Type				
	100 MHZ	30.0 dB Type				
Hi-Pot	1500 Vrms	60 sec.				
Standard-LED						
Color	Green	Yellow				
Wave length	565 nm	585 nm				
Forward voltage with I <sub>F</sub> =20 mA	2.6 V (max)	2.6 V (max)				
	2.1 V (Type)	2.0 V (Type)				
Reserve voltage with $I_R = 10 \ \mu A$	5.0 V (Type)	5.0 V (Type)				
Luminous intensity with I <sub>F</sub> =20 mA	15 mcd (min)	20 mcd (min)				
	25 mcd (Type)	30 mcd (Type)				
	20					

#### **SCHEMATICS**

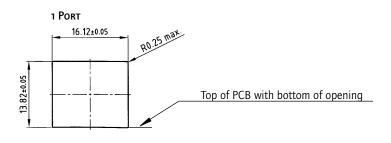
Schematic of magnetic Circuit with Tx/Rx = 1:1/1:1 or Tx/Rx = 1:1.414/1:1 - Turns Ratio, additional shount Chok,  $4x0,75\Omega$  Terminal Resistors - 1000pF/2kv Capacitor and LEDs (Optional)

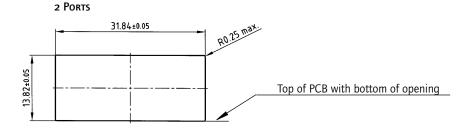


Schematic of magnetic Circuit with Tx/Rx = 1:1/1:1 or Tx/Rx = 1:1.414/1:1 - Turns Ratio, additional  $4x0,75\Omega$  Terminal Resistors - 1000pF/2kv Capacitor and LEDs (Optional).

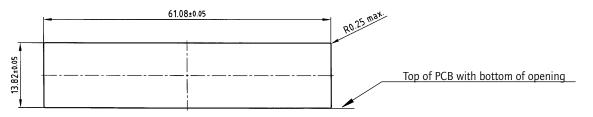


### **Recommended Panel cut-out**

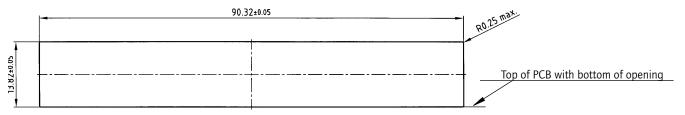




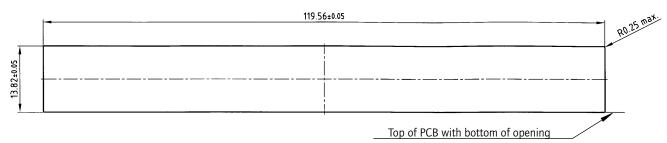
4 Ports



6 Ports

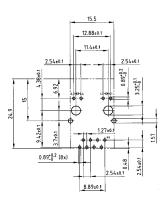


8 Ports

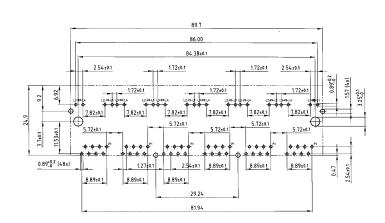


## PCB LAYOUT FOR SOLDER PIN STRAIGHT

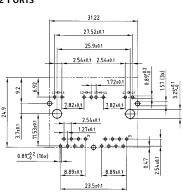
1 Port



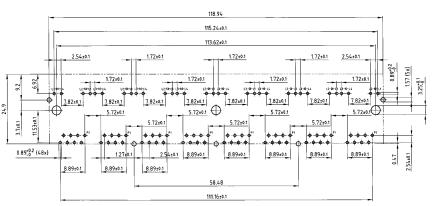
6 Ports



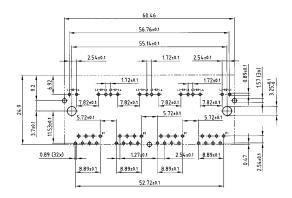
2 Ports



8 Ports

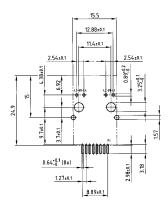


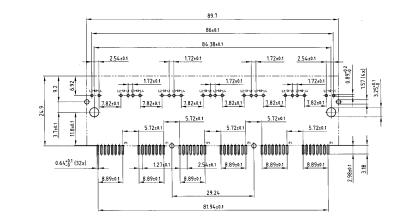
4 Ports



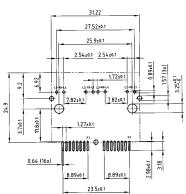
### PCB LAYOUT FOR SMT-TERMINATION

#### 1 Port



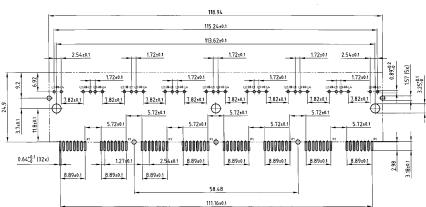


#### 2 Ports

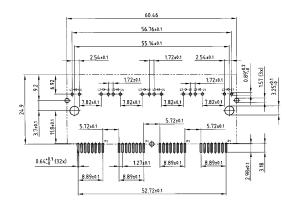


8 Ports

6 Ports







## Solder Profile

Connector Tuno	Preheating		Solder terminal dipping parameters					
Connector Type	max. Temperature	Duration	max. Solder bath Temperature	max. Terminal Immersion Time				
Filter D-SUB	100°C	30s	260°C	5s				
Combo D-SUB Filter	120°C	120s	260°C	5s				
Filter D-SUB Water Resistant	100°C	30s	240°C	5s				
Combo D-SUB Water Resistant	120°C	120s	240°C	5s				
D-SUB Water Resistant	120°C	120s	240°C	5s				
D-SUB Solid Body Type Water Resistant	150°C	180s	265°C	8s				
RJ45 Modular Jack Filtered	150°C	180s	265°C	8s				
Filter Plates	150°C	180s	265°C	8s				

Recommended wave-solder parameters for CONEC connectors.

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